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Cree® XLamp® XM-L™ Color LEDs



PRODUCT DESCRIPTION

The XLamp® XM-L™ Color LED is a multicolor LED that provides high lumen output in a small package. Compared to discrete LEDs, XLamp XM-L Color LEDs reduce the distance between LED die, creating a small optical source for excellent optical control and efficient color mixing. XLamp XM-L Color LEDs can reduce LED system complexity by reducing the number of components required.

Cree XLamp XM-L Color LEDs bring high performance and quality of light to a wide range of lighting applications, including color-changing lighting, stage lighting, architectural lighting, indoor directional lighting, and entertainment lighting.

FEATURES

- Available in red, green, blue and white in a single 5 mm x 5 mm package
- Maximum drive current per LED die:
 1 A
- · Individually addressable LEDs
- Reflow solderable JEDEC J-STD-020
- Electrically neutral thermal path
- · RoHS compliant
- UL® recognized component (E349212)

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CHARACTERISTICS - COMPLETE PACKAGE

The following table lists the product characteristics for the XLamp XM-L Color LED package, measured with all LED dies on simultaneously and each LED die connected to independent drive circuits at 350 mA.

Characteristics	Unit	Minimum	Typical	Maximum
Thermal resistance, junction to solder point	°C/W		3.5	
Viewing angle (FWHM)	degrees (°)		130	
ESD withstand voltage (HBM per Mil-Std-883D)	V			8000
LED junction temperature	°C			150

CHARACTERISTICS - PER LED DIE

The following table lists the product characteristics for each LED die within the XLamp XM-L Color LED package.

Characteristics	Unit	Minimum	Typical	Maximum
Temperature coefficient of voltage - red	mV/°C		-1.8	
Temperature coefficient of voltage - green	mV/°C		-4	
Temperature coefficient of voltage - blue, white	mV/°C		-3	
DC forward current - red, green, blue, white	mA			1000
Forward voltage (@ 350 mA, 25 °C) - red	V		2.25	2.6
Forward voltage (@ 350 mA, 25 °C) - green	V		3.3	3.9
Forward voltage (@ 350 mA, 25 °C) - blue, white	V		3.1	3.7



FLUX CHARACTERISTICS, (T, = 25 °C)

The following tables provide several base order codes for XM-L Color LEDs. For a complete description of the order code nomenclature, please refer to the Bin and Order Code Formats section (page 6).

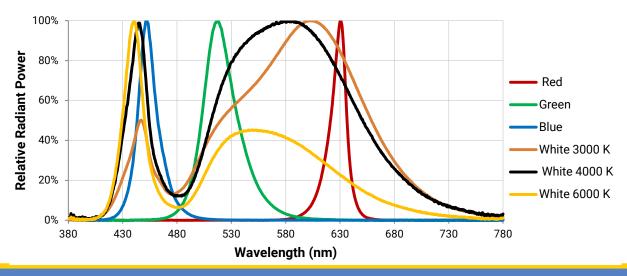
Color		CCT / Dominant Wavelength Range		Minimum Luminous Flux @ 350 mA		Order Code	
		Minimum	Maximum	Group	Flux (lm)		
	Red	620 nm	630 nm		45.7		
Color +	Green	520 nm	535 nm	C3	87.4	XMLCTW-A0-0000-00C3AAAA1	
Cool White	Blue	450 nm	465 nm	CS	13.9	AIVILOT W-AU-0000-00CSAAAAT	
	Cool White	5700 K	8000 K		100		
	Red	620 nm	630 nm	C2		45.7	
Color +	Green	520 nm	535 nm		87.4	XMLCTW-A0-0000-00C2AAAB1	
Neutral White	Blue	450 nm	465 nm		13.9	AMILOTW-AU-0000-000ZAAABT	
	Neutral White	3700 K	4300 K		80		
	Red	620 nm	630 nm		45.7		
Color +	Green	520 nm	535 nm	00	87.4	VAM OTW AO 0000 0000 A A 01	
Warm White	Blue	450 nm	465 nm	C2	13.9	XMLCTW-A0-0000-00C2AAAC1	
	Warm White	2700 K	3700 K		80		

Notes:

- Cree maintains a tolerance of ±7% on flux and power measurements, ±0.005 on chromaticity (CCx, CCy) measurements and ±1 nm on dominant wavelength measurements. See the Measurements section (page 11).
- Flux and chromaticity are measured with each LED die connected to independent drive circuits at 350 mA. The flux and chromaticity of each LED die within the XLamp XM-L Color LED package are measured individually.

The following graph represents typical spectral output of the XM-L RGBW Color LED with each LED on independently. REWhite/3000ECdata from XPG3 (XPGDLDatasheet=160320.2ndrobotoxisx)5 °C)

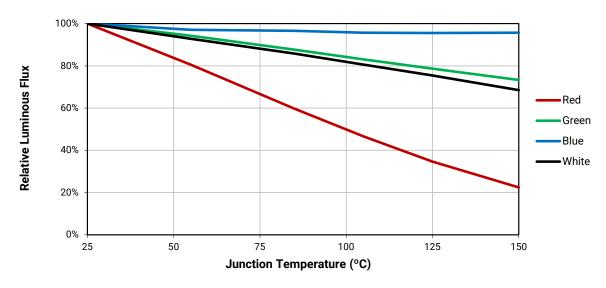
The following graph represents typical spectral output of the XLamp XM-L Color LED with each LED die on independently.





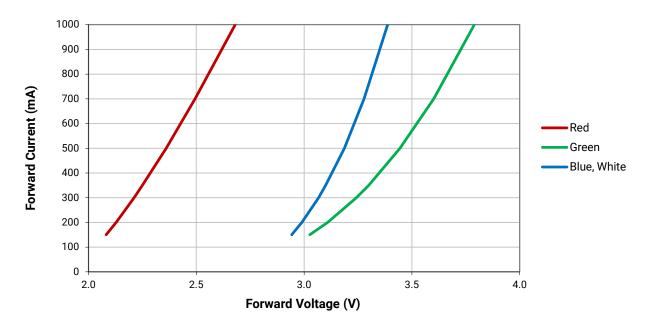
The following graph represents typical performance of each LED die in the XM-L RGBW LED

The following graph represents typical performance of each LED die in the XLamp XM-L Color LED.



ETRE following graph represents typical performance of each LED die in the XM-L RGBW LED

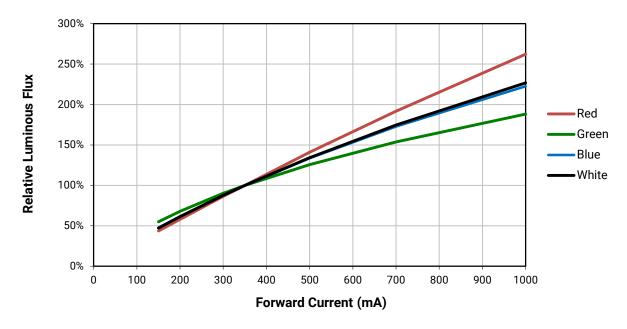
The following graph represents typical performance of each LED die in the XLamp XM-L Color LED.





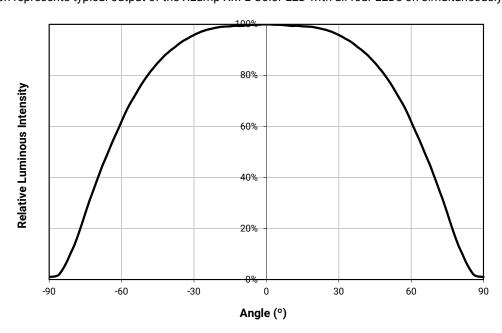
RELATIVE FLUX VS. CURRENT (T₁ = 25 °C)

The following graph represents typical performance of each LED die in the XLamp XM-L Color LED.



TYPICAL SPATIAL DISTRIBUTION

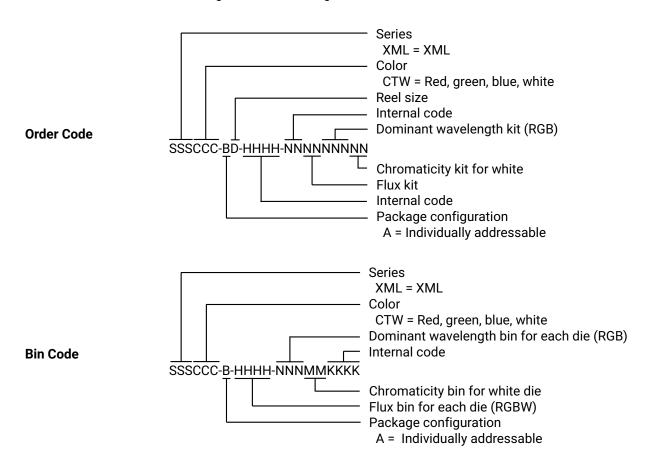
The following graph represents typical spectral output of the XLamp MC E LED with all four LEDs on simultaneously.





BIN AND ORDER CODE FORMATS

Bin codes and order codes are configured in the following manner:



PERFORMANCE GROUPS - LUMINOUS FLUX

Each LED die in the XLamp XM-L Color LED is tested individually for luminous flux and placed into one of the following luminous-flux groups.

Color	Group Code	Minimum Luminous Flux (lm) @ 350 mA	Maximum Luminous Flux (lm) @ 350 mA)
Red	М	45.7	87.4
Red	N	87.4	114
Green	N	87.4	114
Green	Р	114	148
Blue	F	13.9	39.8
	2	80	100
White	3	100	120
	4	120	140

· Flux and chromaticity are measured with each LED die connected to independent drive circuits at 350 mA.



PERFORMANCE GROUPS - CHROMATICITY (I_F = 350 mA PER LED DIE)

The white LED die in the XLamp XM-L Color LED is individually tested for chromaticity at 350 mA and placed into one of the regions defined by the bounding coordinates shown below.

Region	х	у	Region	х	у
	.295	.297		.316	.332
WM	.308	.311	wc	.317	.319
VVIVI	.310	.300	VVC	.308	.311
	.298	.288		.306	.322
	.306	.322		.314	.355
WB	.308	.311	WF	.316	.332
VVD	.295	.297	WF	.306	.322
	.292	.306		.301	.342
	.301	.342		.329	.345
WE	.306	.322	WD	.329	.330
VVE	.292	.306	VVD	.317	.319
	.287	.321		.316	.332
	.308	.311		.329	.369
WN	.317	.319	WG	.329	.345
VVIN	.318	.308	VVG	.316	.332
	.310	.300		.314	.355

Region	х	у	Region	х	у	Region	х	у	Region	х	у
	.3670	.3578		.3702 .3722 .3825 .3798	.3722		.3783	.3646			
5A	.3702	.3722	5B	.3736	.3874	.3874 .3958 .3798	.3869	.3958	ED	.3825	.3798
JA	.3825	.3798	ЭВ	.3869	.3958		.4006	.4044	5D	.3950	.3875
	.3783	.3646		.3825	.3798		.3950	.3875		.3898	.3716
	.4147	.3814		.4221	.3984	.3984	.4342	.4028		.4259	.3853
7A	.4221	.3984	70	.4299	.4165	70	.4430	.4212	7D	.4342	.4028
/A	.4342	.4028	7B	.4430	.4212	7C	.4562	.4260	70	.4465	.4071
	.4259	.3853		.4342	.4028		.4465	.4071		.4373	.3893



PERFORMANCE GROUPS - DOMINANT WAVELENGTH

The red, green and blue LED dies in the XLamp XM-L Color LED are tested individually for dominant wavelength (DWL) and sorted into one of the DWL bins defined below.

Color	DWL Group	Minimum DWL @ 350 mA	Maximum DWL @ 350 mA
	K	450	455
Blue	L	455	460
	M	460	465
	2	520	525
Green	3	525	530
	4	530	535
Red	Α	620	630

STANDARD ORDER CODES AND BINS

The following table list sstandard kit numbers and performance bins. Kit numbers completely describe an order code's color or chromaticity bins and luminous flux range.

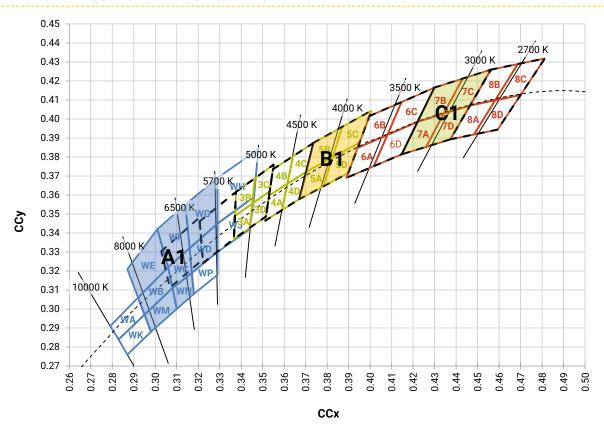
Color		inous Flux (lm)) mA*	DWL / Chromaticity Bins	Kit Number	
	Group	Flux (lm)			
Red	M	45.7	Α		
Green	N	87.4	2, 3, 4	000000000	
Blue	F	13.9	K, L, M	00C3AAAA1	
White	3	100	WC, WD, WF, WG, WB, WE, WM, WN		
Red	М	45.7	А		
Green	N	87.4	2, 3, 4	00C2AAAB1	
Blue	F	13.9	K, L, M		
White	2	80	5A, 5B, 5C, 5D		
Red	М	45.7	А		
Green	N	87.4	2, 3, 4	00C2AAAC1	
Blue	F	13.9	K, L, M		
White	2	80	7A, 7B, 7C, 7D		

For other flux and chromaticity combinations, contact Cree or an authorized distributor.

* Cree XLamp XM-L Color LED order codes specify only a minimum flux bin and not a maximum. Cree may ship reels in flux bins higher than the minimum specified by the order code without advance notice. Shipments will always adhere to the chromaticity or DWL bin restrictions specified by the order code.



STANDARD ORDER CODES AND BINS - CONTNUED

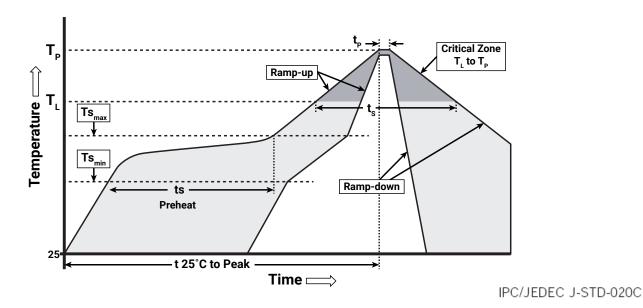




REFLOW SOLDERING CHARACTERISTICS

In testing, Cree has found XLamp XM-L Color LEDs to be compatible with JEDEC J-STD-020C, using the parameters listed below. As a general guideline, Cree recommends that users follow the recommended soldering profile provided by the manufacturer of the solder paste used, and therefore it is the lamp or luminaire manufacturer's responsibility to determine applicable soldering requirements.

Note that this general guideline may not apply to all PCB designs and configurations of reflow soldering equipment.



Profile Feature	Lead-Free Solder
Average Ramp-Up Rate $(Ts_{max} to T_p)$	1.2 °C/second
Preheat: Temperature Min (Ts _{min})	120 °C
Preheat: Temperature Max (Ts _{max})	170 °C
Preheat: Time (ts _{min} to ts _{max})	65-150 seconds
Time Maintained Above: Temperature (T_L)	217 °C
Time Maintained Above: Time (t _L)	45-90 seconds
Peak/Classification Temperature (Tp)	235 - 245 °C
Time Within 5 °C of Actual Peak Temperature (tp)	20-40 seconds
Ramp-Down Rate	1 - 6 °C/second
Time 25 °C to Peak Temperature	4 minutes max.

Note: All temperatures refer to the topside of the package, measured on the package body surface.



NOTES

Measurements

The luminous flux, radiant power, chromaticity, forward voltage and CRI measurements in this document are binning specifications only and solely represent product measurements as of the date of shipment. These measurements will change over time based on a number of factors that are not within Cree's control and are not intended or provided as operational specifications for the products. Calculated values are provided for informational purposes only and are not intended or provided as specifications.

Pre-Release Qualification Testing

Please read the LED Reliability Overview for details of the qualification process Cree applies to ensure long-term reliability for XLamp LEDs and details of Cree's pre-release qualification testing for XLamp LEDs.

RoHS Compliance

The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2011/65/EC (RoHS2), as implemented January 2, 2013. RoHS Declarations for this product can be obtained from your Cree representative or from the Product Ecology section of the Cree website.

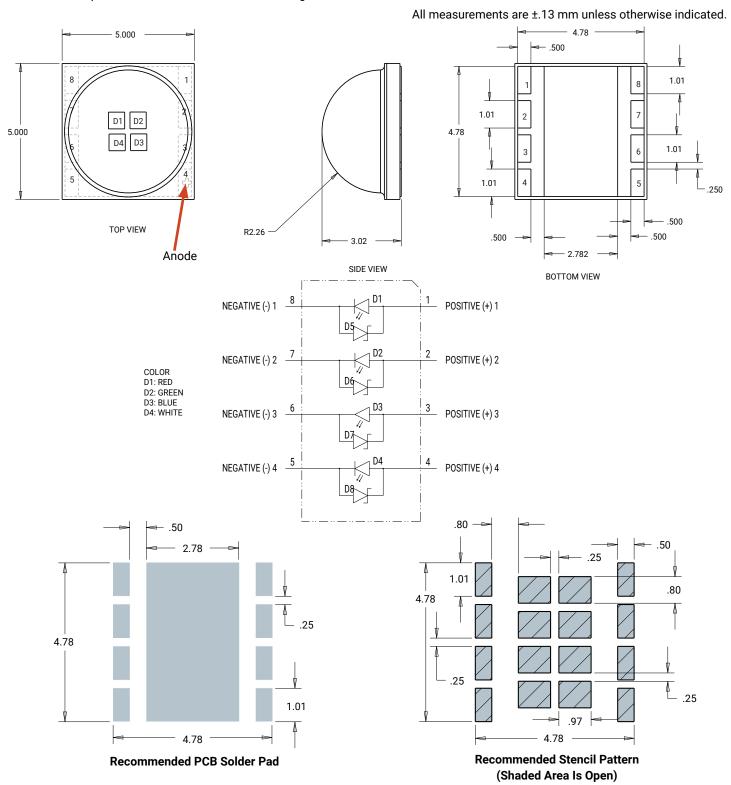
UL® Recognized Component

This product meets the requirements to be considered a UL Recognized Component with Level 4 enclosure consideration. The LED package or a portion thereof has been investigated as a fire and electrical enclosure per ANSI/UL 8750.

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MECHANICAL DIMENSIONS

Thermal vias, if present, are not shown on these drawings.

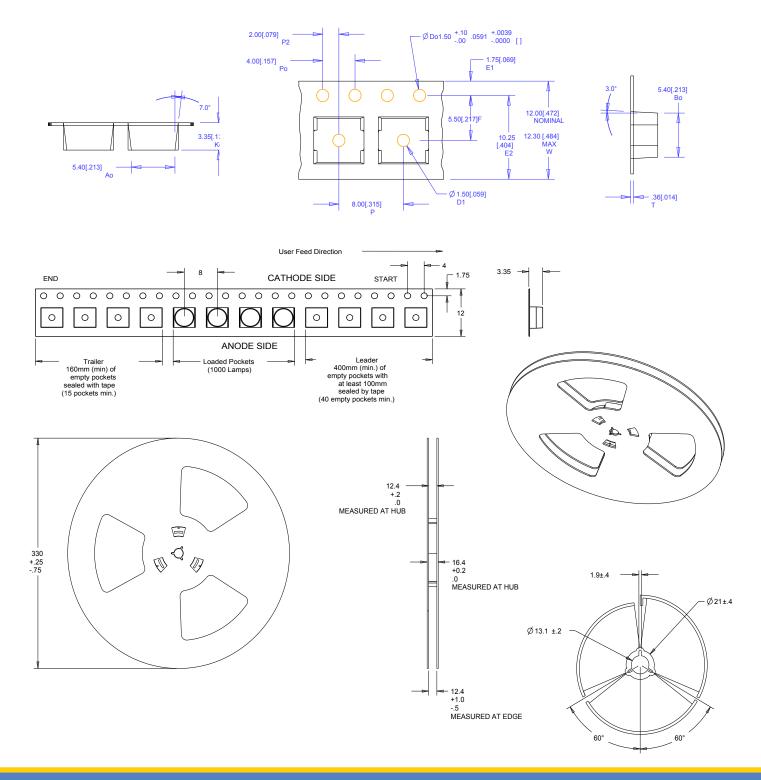




TAPE AND REEL

All Cree carrier tapes conform to EIA-481D, Automated Component Handling Systems Standard.

All dimensions in mm.





PACKAGING

